

**PATENT NUMBER and
ISSUE DATE**

U.S. UTILITY Patent Application

APPLICATION NUMBER	FILING DATE	CLASS	SUBCLASS	GROUP ART UNIT	EXAMINER
APPL NUM 10050014	FILING DATE 01/17/2002	CLASS 205	SUBCLASS —	GAU 1741	
**APPLICANTS: Khaselev Oscar; Zavarine Igor; Zhang Yun;					
**CONTINUING DATA VERIFIED:					
** FOREIGN APPLICATIONS VERIFIED:					
PG-PUB	DO NOT PUBLISH <input type="checkbox"/>	RESCIND <input type="checkbox"/>			
Foreign priority claimed 35 USC 119 conditions met		<input type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> yes <input type="checkbox"/> no	ATTORNEY DOCKET NO KHASELEV 2-2-28		
Verified and Acknowledged Examiners's initials					
TITLE : Electroplating solution for high speed plating of tin-bismuth solder					
U.S.DEP.T OF COMM./PAT & TM-PTO-436L(Rev. 12-94)					

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Assistant Examiner	
		Total Claims	Print Claim for O.G
ISSUE FEE		DRAWING	
Amount Due	Date Paid	Sheets Drwg.	Figs.Drwg.
		Print Fig.	
TERMINAL		Primary Examiner	
DISCLAIMER		Application Examiner	
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